Triacs logic level

BT131W series

GENERAL DESCRIPTION

Passivated, sensitive gate triacs in a plastic envelope suitable for surface mounting, intended for use in general purpose bidirectional switching and phase control applications. These devices are intended to be interfaced directly to microcontrollers, logic integrated circuits and other low power gate trigger circuits.

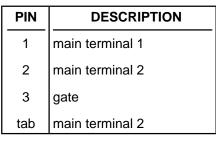
PINNING - SOT223

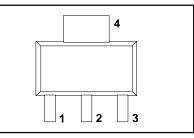
QUICK REFERENCE DATA

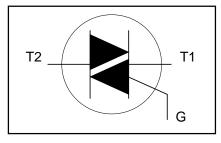
SYMBOL	PARAMETER	MAX.	MAX.	UNIT
V _{drm} I _{t(rms)} I _{tsm}	BT131W- Repetitive peak off-state voltages RMS on-state current Non-repetitive peak on-state current	500 500 1 12.5	600 600 1 12.5	V A A

PIN CONFIGURATION

SYMBOL







LIMITING VALUES

Limiting values in accordance with the Absolute Maximum System (IEC 134).

SYMBOL	PARAMETER	CONDITIONS	MIN.	MA	AX.	UNIT
V _{drm}	Repetitive peak off-state voltages		-	-500 500 ¹	-600 600 ¹	V
I _{T(RMS)} I _{TSM}	RMS on-state current Non-repetitive peak on-state current	full sine wave; $T_{sp} \le 110$ °C full sine wave; $T_j = 25$ °C prior to surge	-		1	A
		t = 20 ms	-		2.5	A
l ² t	1 ² t for fusing	t = 16.7 ms	-		3.8	A A ² s
l t dl _⊤ /dt	I ² t for fusing Repetitive rate of rise of on-state current after	t = 10 ms $I_{TM} = 1.5 \text{ A}; I_G = 0.2 \text{ A};$ $dI_G/dt = 0.2 \text{ A}/\mu \text{s}$	-	0	.5	AS
	triggering	T2+ G+ T2+ G-	-		0 0	A/μs A/μs
		T2- G- T2- G+	-	5	0	A∕µs
I _{GM} V _{GM} P _{GM}	Peak gate current Peak gate voltage Peak gate power	12- 0+	-		0 2 5 5	A/μs Å V W
$\begin{array}{c} P_{G(AV)}\\ P_{G(AV)}\\ T_{stg}\\ T_{j} \end{array}$	Average gate power Storage temperature Operating junction temperature	over any 20 ms period	- -40 -	0 1:	.5 50 25	ů Č Ň

¹ Although not recommended, off-state voltages up to 800V may be applied without damage, but the triac may switch to the on-state. The rate of rise of current should not exceed 3 $A/\mu s$.

BT131W series

THERMAL RESISTANCES

SYMBOL	PARAMETER	CONDITIONS	MIN.	TYP.	MAX.	UNIT
	Thermal resistance	full or half cycle	-	-	15	K/W
	junction to solder point		-	-	-	K/W
R _{th i-a}	Thermal resistance	pcb mounted; minimum footprint	-	156	-	K/W
, .	junction to ambient	pcb mounted; pad area as in fig:14	-	70	-	K/W

STATIC CHARACTERISTICS

 $T_i = 25$ °C unless otherwise stated

SYMBOL	PARAMETER	CONDITIONS		MIN.	TYP.	MAX.	UNIT
I _{GT}	Gate trigger current	$V_{\rm D} = 12 \text{ V}; I_{\rm T} = 0.1 \text{ A}$					
01			2+ G+	-	0.4	3	mA
		T2	2+ G-	-	1.3	3	mA
		T2	2-G-	-	1.4	3	mA
			2- G+	-	3.8	7	mA
I _L	Latching current	$V_{\rm D} = 12 \text{ V}; I_{\rm GT} = 0.1 \text{ A}$					
		T2	2+ G+	-	1.2	5	mA
		T2	2+ G-	-	4.0	8	mA
			2-G-	-	1.0	5	mA
			2- G+	-	2.5	8	mA
I _H	Holding current	$V_{\rm D} = 12 \text{ V}; I_{\rm GT} = 0.1 \text{ A}$		-	1.3	5	mA
∣I _H V _T V _{GT}	On-state voltage	$I_{T} = 1.4 \text{ A}$		-	1.2	1.5	V
V _{GT}	Gate trigger voltage	$V_{\rm D} = 12 \text{ V}; \text{ I}_{\rm T} = 0.1 \text{ A}$		-	0.7	1.5	V
		$ V_{D} = 400 V; I_{T} = 0.1 A; T_{i} = 125 °C$		0.2	0.3	-	V
I _D	Off-state leakage current	$V_{D}^{U} = 400 \text{ V}; I_{T} = 0.1 \text{ A}; T_{j} = 125 \text{ °C}$ $V_{D} = V_{DRM(max)}; T_{j} = 125 \text{ °C}$		-	0.1	0.5	mA

DYNAMIC CHARACTERISTICS

 $T_i = 25$ °C unless otherwise stated

SYMBOL	PARAMETER	CONDITIONS	MIN.	TYP.	MAX.	UNIT
dV _D /dt	Critical rate of rise of	$V_{DM} = 67\% V_{DRM(max)}; T_j = 125 °C;$	10	20	-	V/µs
dV _{com} /dt	off-state voltage Critical rate of change of	exponential waveform; $R_{GK} = 1 k\Omega$ $V_{DM} = 400 V; T_j = 125 °C;$	2	-	-	V/μs
t _{gt}	commutating voltage Gate controlled turn-on time		-	2	-	μs

Triacs logic level

BT131W series

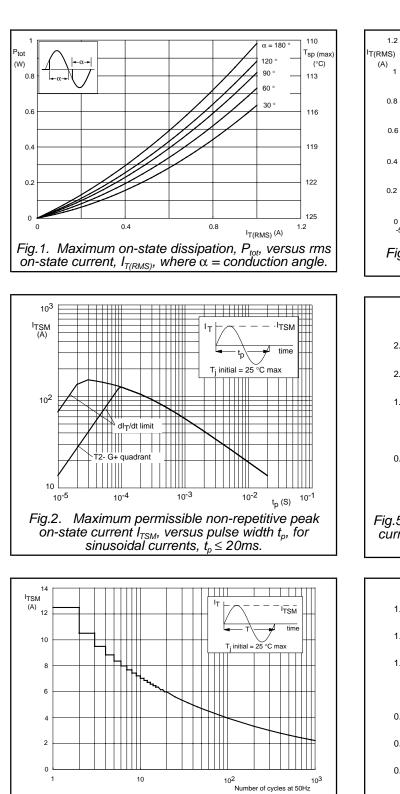
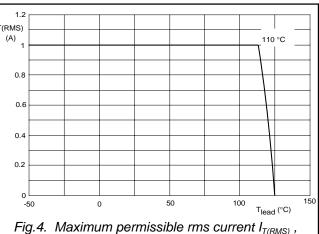


Fig.3. Maximum permissible non-repetitive peak

on-state current ITSM, versus number of cycles, for

sinusoidal currents, f = 50 Hz.



versus solder point temperature T_{sp} .

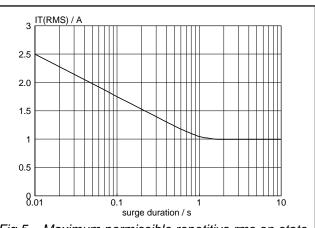
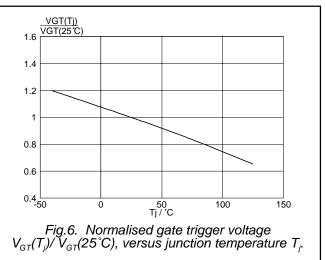
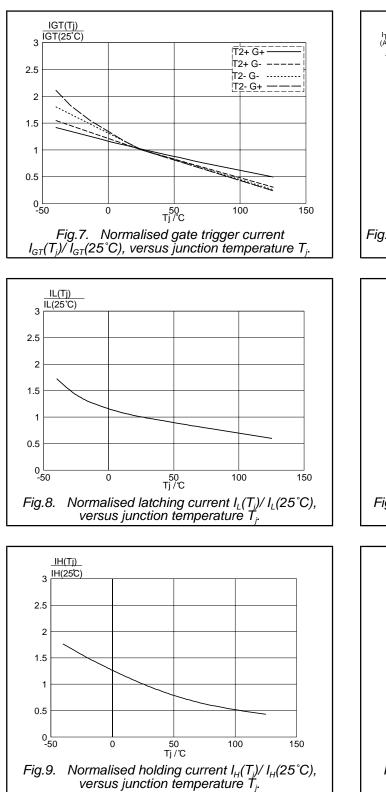


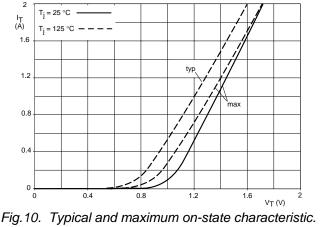
Fig.5. Maximum permissible repetitive rms on-state current $I_{T(RMS)}$, versus surge duration, for sinusoidal currents, f = 50 Hz; $T_{lead} \le 110^{\circ}$ C.

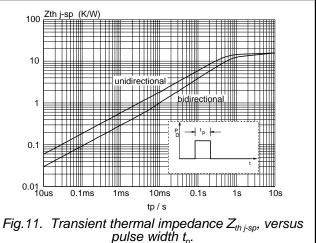


Triacs logic level

BT131W series







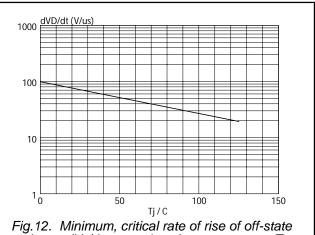
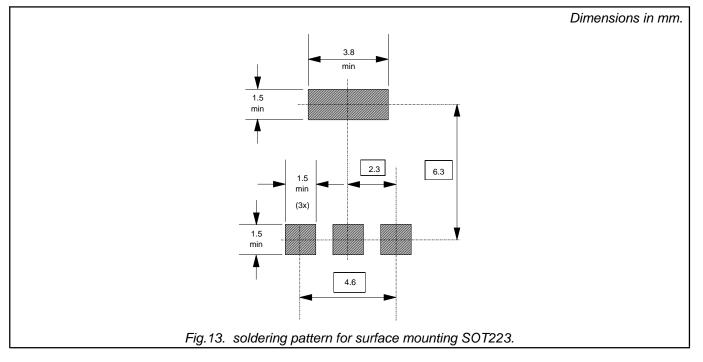


Fig. 12. Minimum, critical rate of rise of off-state voltage, dV_D/dt versus junction temperature T_j .

BT131W series

Triacs logic level

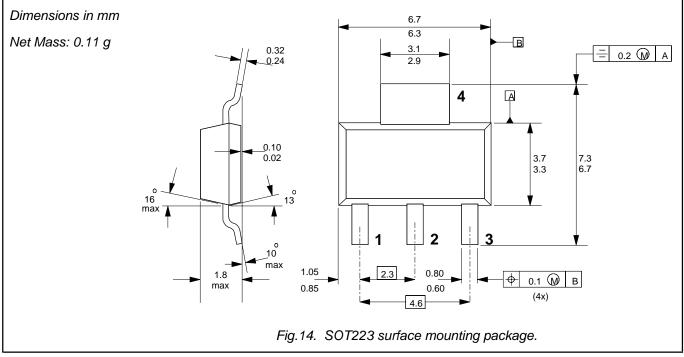
MOUNTING INSTRUCTIONS



Product specification

BT131W series

MECHANICAL DATA



Notes

For further information, refer to Philips publication SC18 " SMD Footprint Design and Soldering Guidelines". Order code: 9397 750 00505.
Epoxy meets UL94 V0 at 1/8".

Triacs	BT131W series
logic level	

DEFINITIONS

Data sheet status				
Objective specification	This data sheet contains target or goal specifications for product development.			
Preliminary specification	This data sheet contains preliminary data; supplementary data may be published later.			
Product specification	This data sheet contains final product specifications.			
Limiting values				
Limiting values are given in accordance with the Absolute Maximum Rating System (IEC 134). Stress above one or more of the limiting values may cause permanent damage to the device. These are stress ratings only and operation of the device at these or at any other conditions above those given in the Characteristics sections of this specification is not implied. Exposure to limiting values for extended periods may affect device reliability.				
Application information				
Where application information is given, it is advisory and does not form part of the specification.				

© Philips Electronics N.V. 2004

All rights are reserved. Reproduction in whole or in part is prohibited without the prior written consent of the copyright owner.

The information presented in this document does not form part of any quotation or contract, it is believed to be accurate and reliable and may be changed without notice. No liability will be accepted by the publisher for any consequence of its use. Publication thereof does not convey nor imply any license under patent or other industrial or intellectual property rights.

LIFE SUPPORT APPLICATIONS

These products are not designed for use in life support appliances, devices or systems where malfunction of these products can be reasonably expected to result in personal injury. Philips customers using or selling these products for use in such applications do so at their own risk and agree to fully indemnify Philips for any damages resulting from such improper use or sale.